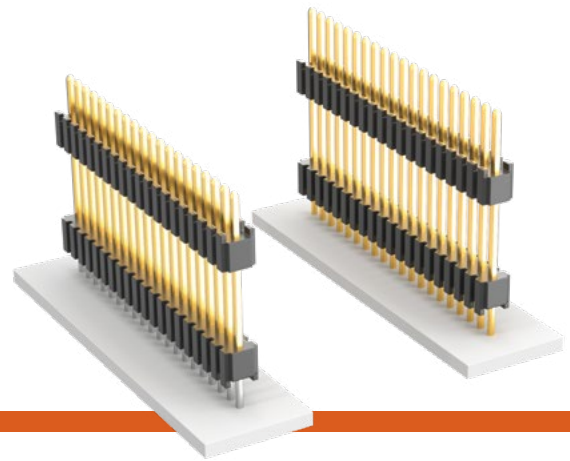


MICRO BOARD STACKER

(1.27 mm) .050" PITCH • DWM/HDWM SERIES



DWM/HDWM

Mates:

SMS, SLM, RSM

SPECIFICATIONS

Insulator Material:

Liquid Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over 50 μ " (1.27 μ m) Ni

Operating Temp Range:

-55 °C to +105 °C with Tin

-55 °C to +125 °C with Gold

PROCESSING

Lead-Free Solderable:

Yes

SMT Lead Coplanarity:

(0.15 mm) .006" max*

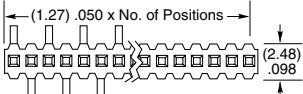
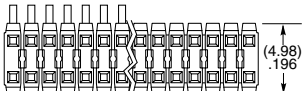
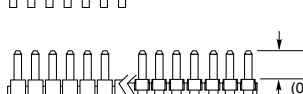
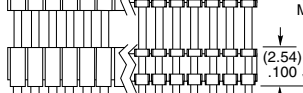
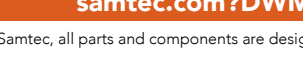
*(.004" stencil solution may be available; contact

ipg@samtec.com)

ALSO AVAILABLE

Other Platings
(MOQ Required)

DWM	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	STACKER HEIGHT	OTHER OPTION																												
	01 thru 50	Specify LEAD STYLE from chart	-L = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail -G = 10 μ" (0.25 μm) Gold on contact, Gold flash on tail	-S = Single Row -D = Double Row	- "XXX" = Stacker Height Example: -200 = (5.08 mm) .200"	- "XXX" = Polarized Position (Specify position of omitted pin)																												
<table><tr><th colspan="2">OAL</th></tr><tr><th>LEAD STYLE</th><th>THROUGH-HOLE</th></tr><tr><td>-01</td><td>(11.43) .450</td></tr><tr><td>-51</td><td>(10.41) .410</td></tr><tr><td>-52</td><td>(10.80) .425</td></tr><tr><td>-53</td><td>(12.83) .505</td></tr><tr><td>-54</td><td>(14.10) .555</td></tr><tr><td>-55</td><td>(15.49) .610</td></tr><tr><td>-56</td><td>(15.88) .625</td></tr><tr><td>-57</td><td>(16.51) .650</td></tr><tr><td>-58</td><td>(17.91) .705</td></tr><tr><td>-59</td><td>(19.18) .755</td></tr><tr><td>-60</td><td>(20.96) .825</td></tr><tr><td>-61</td><td>(26.67) 1.050</td></tr></table>							OAL		LEAD STYLE	THROUGH-HOLE	-01	(11.43) .450	-51	(10.41) .410	-52	(10.80) .425	-53	(12.83) .505	-54	(14.10) .555	-55	(15.49) .610	-56	(15.88) .625	-57	(16.51) .650	-58	(17.91) .705	-59	(19.18) .755	-60	(20.96) .825	-61	(26.67) 1.050
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HDWM	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION	STACKER HEIGHT	OTHER OPTION
FACE COUNT	01 thru 50	Specify LEAD STYLE from chart	-L = 10 μ" (0.25 μm) Gold on contact, Matte Tin on tail	-S = Single Row	- "XXX" = Stacker Height Example: -250 = (6.35 mm) .250"	- "XXX" = Polarized Position (Specify position of omitted pin)
			-G = 10 μ" (0.25 μm) Gold on contact, Gold flash on tail	-D = Double Row		- SM = Surface Mount (02 thru 40 positions only)
3). .330						- A = Alignment Pin (6 positions minimum -D only) Metal or plastic at Samtec discretion (Not available with -LC)
5). .385						- LC = Locking Clip (5 positions minimum -D only) (Not available with -A) (Manual placement required)
5). .435						- P = Pick & Place Pad
5). .490						
3). .505						
6). .530						
6). .585						
2). .615						

Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

This Series is non-standard, non-returnable.